4 REVISIONS DESIGN CROSS SECTION CHART DESCRIPTION APPROVED DATE TOTAL THICKNESS 1.6 MM 2017-08-09 | 2017-08-09 Initial Version Production Release Version 2017-10-20 | 2017-10-20 2018-01-04 | 2018-01-04 Production Release Version (Added DustBin Symbol) L1: TOP CONDUCTOR - COPPER + PLATING 0.035 MM 2018-07-09 | 2018-07-09 Updated with new Energy Trace Circuit * DIELECTRIC - FR-4 0.175 MM (TOP PRIORITY) L2: L2 PLANE - COPPER 0.035 MM Production Release Version (Added CE Logo) 2018-10-10 | 2018-10-10 * DIELECTRIC - FR-4 1.11 MM L3: L3 PLANE - COPPER 0.035 MM DIELECTRIC - FR-4 0.175 MM 4: BOTTOM CONDUCTOR - COPPER + PLATING 0.035 MM PANEL DRAWING 4x Ø3 MM TOOLING HOLE (NPTH) 3x Ø1.5 MM FIDUCIAL MARK, ADD BOTH SIDES 58.5 \bigcirc DRILL CHART: TOP to BOTTOM ALL UNITS ARE IN MILLIMETERS ROTATION FIGURE FINISHED SIZE PLATED QTYPLATED 0.2 1369 _ 0.201 PLATED 25 • _ 75 2 MM TYP 1.05 PLATED _ PLATED 1 . 1 _ R5.2 œ 3.2 PLATED 4 0.899 NON-PLATED 6 _ NON-PLATED 1.0 3 . _ NON-PLATED 3.2 . -1.3x0.6 90.000 PLATED 0 TOTAL HOLES: 1487 0 \circ R1.8 TEXAS INSTRUMENTS DRILL WCS042 D DATE: 2018-10-10 FAB NOTES: 1. ALL DIMENSIONS ARE IN MM, UNLESS OTHERWISE NOTED. 2. THE PWB SHALL BE FABRICATED TO IPC-6012, CLASS 2 AND WORKMANSHIP SHALL CONFORM TO IPC-A-600, CLASS 2. CURRENT REVISIONS. 3. BOARD MATERIAL SHALL BE 180 Tg/340 Td ISOLA FR-370HR OR EQUIVALENT, RoHS COMPLIANT AND LEAD FREE ASSEMBLY CAPABLE. BOARD MATERIAL SHALL MEET OR EXCEED IPC-4101B. Rohs/Reach certificate of conformance shall be delivered with each lot 4. BOARD MATERIAL & CONSTRUCTION TO BE U.L. 94V-0 APPROVED AND MARKED ON THE FINISHED BOARD. UL GUIDE NUMBER SHOULD BE MARKED ON THE FINISHED BOARD. 5. OVERALL BOARD THICKNESS TO BE1.6 MM AND APPLIES AFTER ALL LAMINATION AND PLATING PROCESSES, MEASURED FROM COPPER TO COPPER. UNLESS OTHERWISE SPECIFIED SIGNATURES DATE 6. MAX. WARP & TWIST TO BE .0075 PER INCH. TEXAS INSTRUMENTS 7. BOARD MUST BE ELECTRICALLY TESTED USING SUPPLIED IPC-D-356 NETLIST. DIMENSIONS ARE IN MM ΡМ 2018-10-10 8. 0.32MM TRACES ON LAYER 1 ARE 50 OHMS +/-10%. THEY ARE REFERENCE TO LAYER 2 GROUND 9. MANUFACTURER MARKING: TWO LETTER + YEAR + WEEK CHECKED TA,SJ 2018-10-10 THE LETTER CODE SHALL IDENTIFY THE MAUFACTURER AND IS DECIDED BY MFR. NO LOGOS OR OTHER IDENTIFIERS ARE ALLOWED THE MARKING SHALL BE IN BOTTOM SILK SCREEN PRINT FABRICATION DRAWING LAUNCHXL-CC1312R1 CC1312R LaunchPad 1. APPLY LPI SOLDERMASK OVER BARE COPPER (SMOBC), SOLDERMASK SHALL CONFORM TO IPC-SM-840. CLASS H. CURRENT REV. COLOR OF MASK TO BE RED. WCS042 D 2. PLATE ALL EXPOSED AREAS WITH ELECTROLESS NICKEL IMMERSION GOLD. NICKEL: 100 MICRO-INCHES MIN. GOLD: 2-8 MICROINCHES MIN. 3. SOLDERMASK ARTWORK HAS ZERO (0) OVERSIZED PADS.FABRICATION VENDOR IS ALLOWED TO ADJUST THE COMPONENT SOLDERMASK PADS TO MEET THEIR TOOLING REQUIREMENTS. SIZE | FSCM NO DWG NO 4. APPLY NON-CONDUCTIVE LPI SILKSCREEN OR EQUIVALENT PER THE ARTWORK. COLOR: WHITE. 5. ALL VIAS ARE TENTED. SCALE NONE SHEET 1 OF 1